

200V N-Channel Power MOSFET

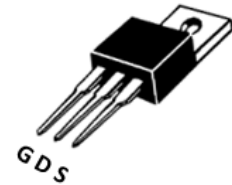
DESCRIPTION :

- Fast Recovery Body Diode
- Low Gate Charge Minimize Switching Loss
- Proprietary New Trench Technology
- $R_{DS(ON),typ.}=9.8m\Omega@V_{GS}=10V$
- RoHS compliant

BV_{DSS}	200V
I_D	110A
$R_{DS(ON) typ.}$	9.8m Ω

TYPICAL APPLICATIONS :

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



TO-220AB

MAXIMUM RATINGS (at $T_C = 25^\circ C$, unless otherwise specified)

Characteristic	Condition	Symbol	Value	Unit
Drain-Source Voltage		V_{DSS}	200	V
Gate-Source Voltage		V_{GSS}	± 20	V
Continuous Drain Current	$T_C=25^\circ C$ $T_C=100^\circ C$	I_D	110 75	A
Pulsed Drain Current ⁽¹⁾	$V_{GS}=10V$	I_{DM}	440	A
Single Pulsed Avalanche Energy	$L=10mH$	E_{AS}	2000	mJ
Power dissipation	$T_C=25^\circ C$	P_D	333	W
Junction & Storage temperature Range		T_J, T_{STG}	-55~+150	$^\circ C$

Notes : 1. Repetitive rating; pulse width limited by maximum junction temperature.

THERMAL CHARACTERISTICS

Characteristic	Condition	Symbol	Value	Unit
Thermal resistance,	Junction – Ambient Junction - Case	$R_{\theta(j-A)}$ $R_{\theta(j-C)}$	62 0.45	$^\circ C/W$

ELECTRICAL CHARACTERISTICS (at $T_J = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage $V_{GS} = 0\text{V}$, $I_D = 250\mu\text{A}$	BV_{DSS}	200			V
Zero Gate Voltage Drain Current $V_{DS} = 200\text{V}$, $V_{GS} = 0\text{V}$ $T_J=25^\circ\text{C}$	I_{DSS}			1	μA
Gate-Source Leakage Current $V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$	I_{GSS}			± 100	nA
Gate-Source threshold voltage $V_{DS} = V_{GS}$, $I_D = 250\mu\text{A}$	$V_{GS(th)}$	2.5		4.5	V
Drain-Source On-State Resistance $V_{GS} = 10\text{V}$, $I_D = 40\text{A}$	$R_{DS(on)}$		9.8	11.5	m Ω
Input capacitance $f=1\text{MHz}$, $V_{DS}=100\text{V}$, $V_{GS}=0\text{V}$	C_{iss}		6792		pF
Output capacitance $f=1\text{MHz}$, $V_{DS}=100\text{V}$, $V_{GS}=0\text{V}$	C_{oss}		389		pF
Reverse transfer capacitance $f=1\text{MHz}$, $V_{DS}=100\text{V}$, $V_{GS}=0\text{V}$	C_{rss}		5.09		pF
Total Gate Charge $V_{DD}= 100\text{V}$, $I_D= 55\text{A}$, $V_{GS}= 10\text{V}$	Q_G		80		nC
Gate to Source Charge $V_{DD}= 100\text{V}$, $I_D= 55\text{A}$, $V_{GS}= 10\text{V}$	Q_{GS}		37		nC
Gate to Drain Charge $V_{DD}= 100\text{V}$, $I_D= 55\text{A}$, $V_{GS}= 10\text{V}$	Q_{GD}		11.5		nC
Turn-on delay time $V_{DD}=100\text{V}$, $V_{GS}= 10\text{V}$, $I_D= 55\text{A}$, $R_{GEN}=4.7\Omega$	$t_{d(ON)}$		38		ns
Turn-on Rise time $V_{DD}=100\text{V}$, $V_{GS}= 10\text{V}$, $I_D= 55\text{A}$, $R_{GEN}=4.7\Omega$	t_r		16		ns
Turn-off delay time $V_{DD}=100\text{V}$, $V_{GS}= 10\text{V}$, $I_D= 55\text{A}$, $R_{GEN}=4.7\Omega$	$t_{d(OFF)}$		43		ns
Turn-off Fall time $V_{DD}=100\text{V}$, $V_{GS}= 10\text{V}$, $I_D= 55\text{A}$, $R_{GEN}=4.7\Omega$	t_f		10		ns

Body Diode

ELECTRICAL CHARACTERISTICS (at $T_J = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Diode Forward Voltage $V_{GS} = 0V, I_S = 80A$	V_{SD}			1.2	V
Continuous Source Current	I_{SD}			110	A
Revers Recovery Time $I_F = 55A, dI_F/dt = 100A/\mu s$	T_{rr}		149		ns
Revers Recovery Charge $I_F = 55A, dI_F/dt = 100A/\mu s$	Q_{rr}		429		nC

Typical Characteristics

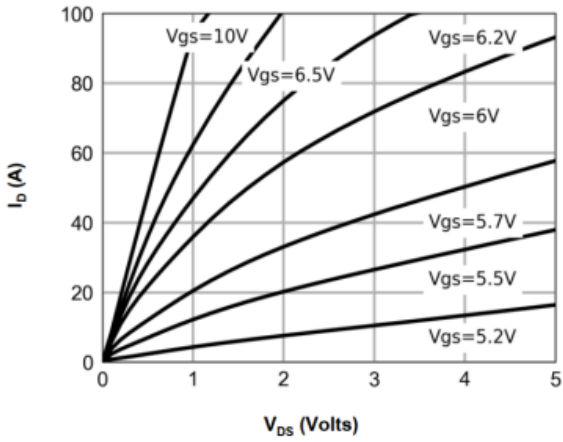


Figure 1. On-Region Characteristics

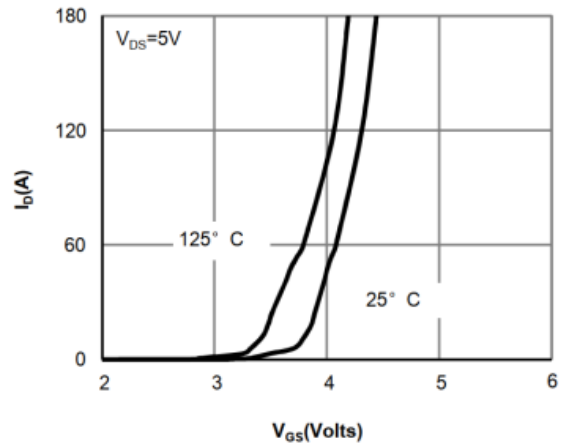


Figure 2. Transfer Characteristics

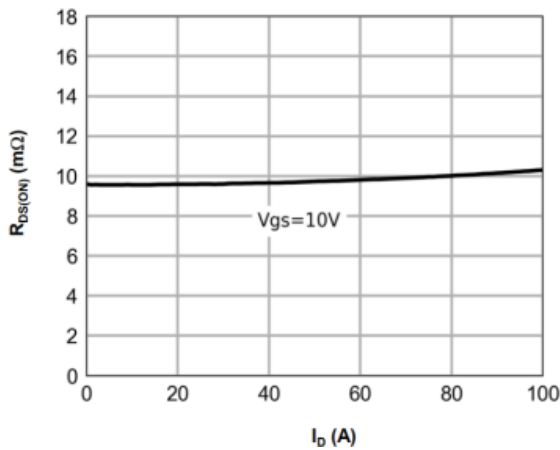


Figure 3. On-resistance vs. Drain Current and Gate Voltage

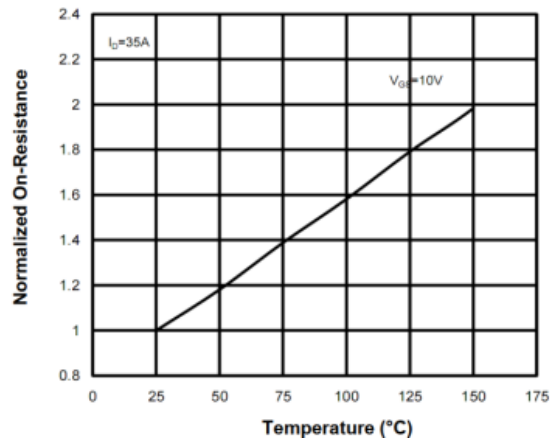


Figure 4. On-resistance vs. Junction Temperature

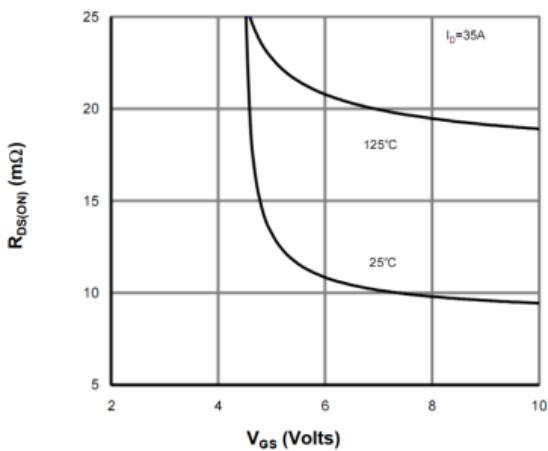


Figure 5. On-resistance vs. Gate-Source Voltage

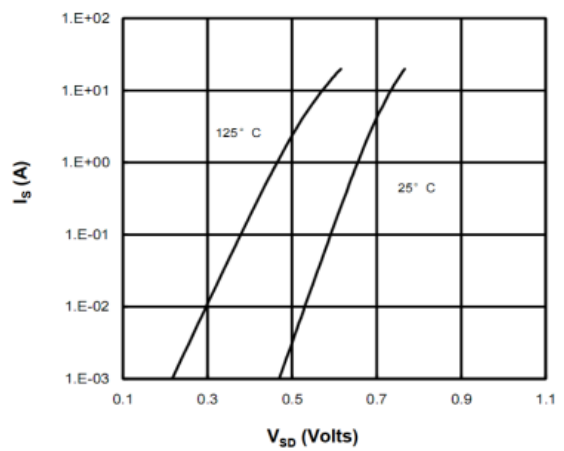


Figure 6. Body-Diode Characteristics

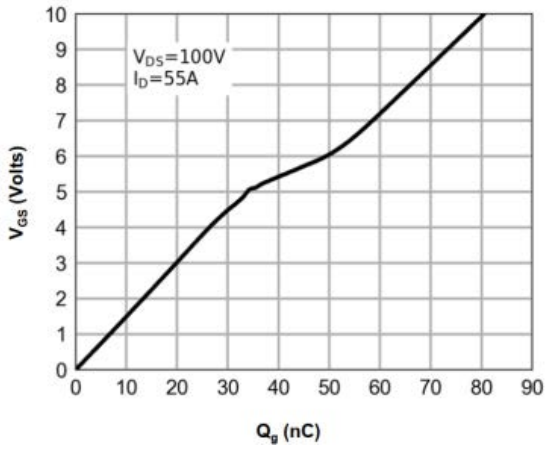


Figure 7. Gate Charge Characteristics

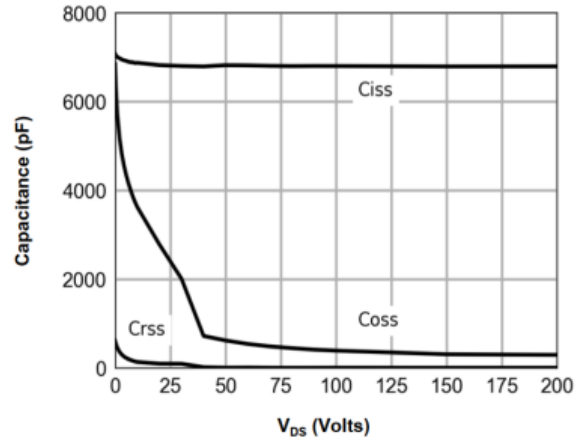


Figure 8. Capacitance Characteristics

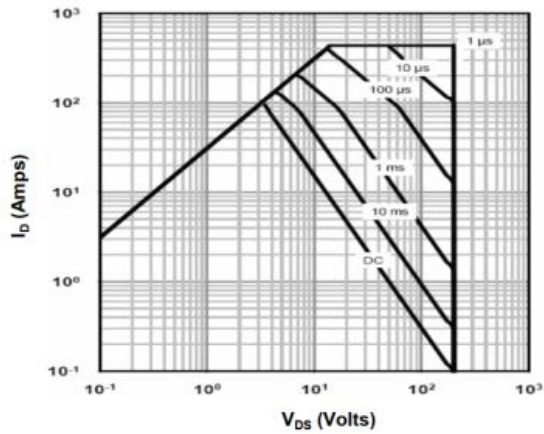
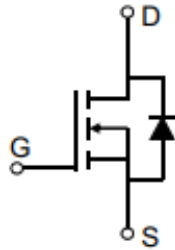
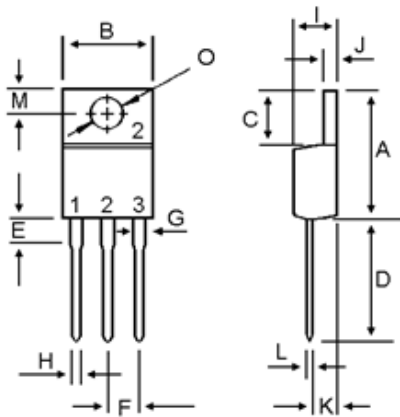


Figure 9. Safe Operating Area

- Circuit diagram



- TO-220AB Package outlines : Dimensions in (mm)



DIM	MILLIMETERS	
	MIN	MAX
A	14.68	16.20
B	9.78	10.42
C	5.02	6.60
D	13.00	14.62
E	3.10	4.19
F	2.41	2.67
G	1.10	1.67
H	0.69	1.01
I	4.22	4.98
J	1.14	1.40
K	2.20	3.30
L	0.28	0.61
M	2.48	3.00
O	3.40	4.00

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